



**DMPH6050SK3** 

#### Product Summary

BV <sub>DSS</sub>	R <sub>DS(ON)</sub> max	l <sub>D</sub> max T <sub>C</sub> = +25°C	
001/	$50m\Omega @ V_{GS} = -10V$	-23.6A	
-60V	70mΩ @ V <sub>GS</sub> = -4.5V	-20A	

60V 175°C P-CHANNEL ENHANCEMENT MODE MOSFET

#### Features

- Rated to +175°C Ideal for High Ambient Temperature Environments
- 100% Unclamped Inductive Switching Ensures More Reliable and Robust End Application
- Low Qg Minimizes Switching Loss
- Low R<sub>DS(ON)</sub> Minimizes On State Loss
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- An Automotive-Compliant Part is Available Under Separate Datasheet (DMPH6050SK3Q)

#### **Description and Applications**

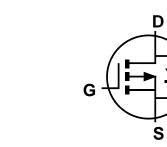
This new generation MOSFET is designed to minimize the on-state resistance (R<sub>DS(ON)</sub>) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

- Load Switch
- **DC-DC Converters**
- Motor Driving



#### **Mechanical Data**

- Case: TO252 (DPAK) •
- Case Material: Molded Plastic, "Green" Molding Compound; UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 @3
- Weight: 0.315 grams (Approximate)



Equivalent Circuit

#### Ordering Information (Note 4)

Top View

Part Number	Case	Packaging
DMPH6050SK3-13	TO252 (DPAK)	2,500/Tape & Reel

D

Π D

Pin Out Top View

G

1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied. Notes:

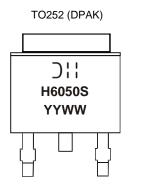
2. See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

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3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

## Marking Information



DII = Manufacturer's Marking H6050S = Product Type Marking Code YYWW = Date Code Marking YY = Last Two Digits of Year (ex: 15 = 2015) WW = Week Code (01 to 53)



# Maximum Ratings (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Drain-Source Voltage	V <sub>DSS</sub>	-60	V		
Gate-Source Voltage			V <sub>GSS</sub>	±20	V
	Steady State	T <sub>C</sub> = +25°C T <sub>C</sub> = +70°C	ID	-23.6 -19	А
Continuous Drain Current (Note 6) $V_{GS} = -10V$	Steady State	T <sub>A</sub> = +25°C T <sub>A</sub> = +70°C	I <sub>D</sub>	-7.2 -6.0	А
Pulsed Drain Current (10µs pulse, duty cycle = 1%)			I <sub>DM</sub>	-40	A
Maximum Continuous Body Diode Forward Current	Is	-3.8	A		
Avalanche Current (Note 7) L = 0.1mH	I <sub>AS</sub>	-25	A		
Avalanche Energy (Note 7) L = 0.1mH			E <sub>AS</sub>	31	mJ

#### Thermal Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)		PD	1.9	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	$R_{ ext{ heta}JA}$	80	°C/W
Total Power Dissipation (Note 6)		PD	3.8	W
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	$R_{ ext{ heta}JA}$	39	°C/W
Thermal Resistance, Junction to Case (Note 6)		R <sub>0JC</sub>	3	C/W
Operating and Storage Temperature Range		TJ, TSTG	-55 to +175	°C

## Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

				1	1		
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 8)							
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	-60			V	$V_{GS} = 0V, I_D = -250\mu A$	
Zero Gate Voltage Drain Current T <sub>J</sub> = +25°C	IDSS	_	—	-1	μA	$V_{DS} = -60V, V_{GS} = 0V$	
Gate-Source Leakage	I <sub>GSS</sub>		—	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 8)							
Gate Threshold Voltage	V <sub>GS(TH)</sub>	-1	—	-3	V	$V_{DS} = V_{GS}, I_D = -250 \mu A$	
Static Drain-Source On-Resistance			—	50	mΩ	$V_{GS} = -10V, I_D = -7A$	
	R <sub>DS(ON)</sub>	—	-	70	11122	$V_{GS} = -4.5V, I_D = -7A$	
Diode Forward Voltage	V <sub>SD</sub>	_	-0.7	-1.2	V	$V_{GS} = 0V, I_{S} = -1A$	
DYNAMIC CHARACTERISTICS (Note 9)							
Input Capacitance	C <sub>iss</sub>	—	1377	—	pF	V <sub>DS</sub> = -30V, V <sub>GS</sub> = 0V, f = 1MHz	
Output Capacitance	Coss	—	87	-	pF		
Reverse Transfer Capacitance	Crss	—	68	-	pF		
Gate Resistance	Rg	_	12	—	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1MHz$	
Total Gate Charge (V <sub>GS</sub> = -4.5V)	Qg	—	12	-	nC		
Total Gate Charge (V <sub>GS</sub> = -10V)	Qg	_	25	—	nC		
Gate-Source Charge	Q <sub>gs</sub>	_	3.8	—	nC	$-V_{DS} = -30V, I_{D} = -5A$	
Gate-Drain Charge	Q <sub>gd</sub>	_	4.9	—	nC	7	
Turn-On Delay Time	t <sub>D(ON)</sub>		5.3	_	ns		
Turn-On Rise Time	t <sub>R</sub>		8.6	_	ns	$V_{DS} = -30V, V_{GS} = -10V, R_G = 3\Omega, I_D = -5A$	
Turn-Off Delay Time	t <sub>D(OFF)</sub>	_	49.4	—	ns		
Turn-Off Fall Time	t <sub>F</sub>		29.7	—	ns	7	
Body Diode Reverse Recovery Time	t <sub>RR</sub>	_	14.2	—	ns		
Body Diode Reverse Recovery Charge	Q <sub>RR</sub>		7.9	—	nC	− I <sub>F</sub> = -5A, di/dt = 100A/µs	

Notes: 5. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.

6. Device mounted on FR-4 substrate PC board, 2oz copper, with 1-inch square copper plate.

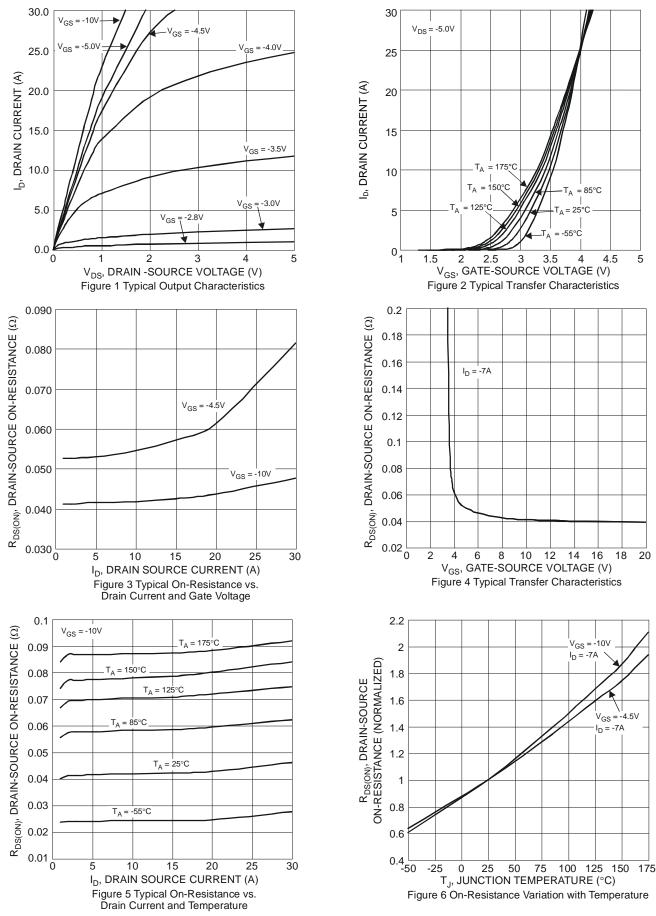
7.  $I_{AS}$  and  $E_{AS}$  rating are based on low frequency and duty cycles to keep  $T_J = +25^{\circ}C$ .

8. Short duration pulse test used to minimize self-heating effect.

9. Guaranteed by design. Not subject to product testing.

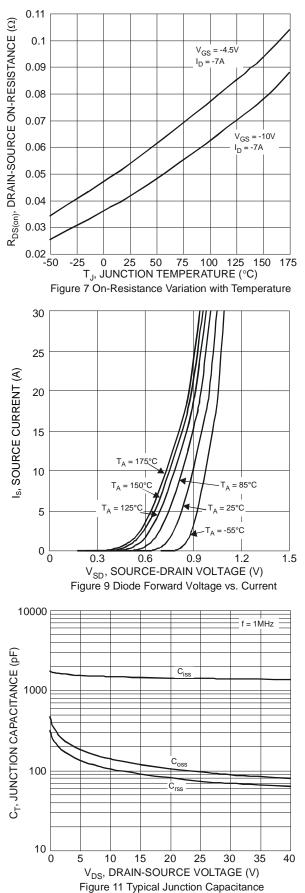


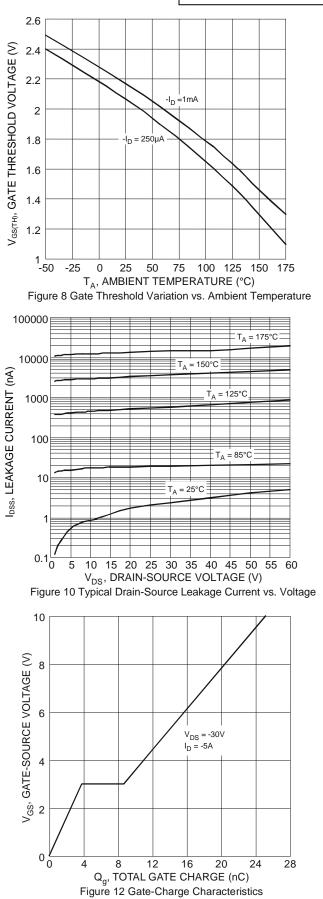






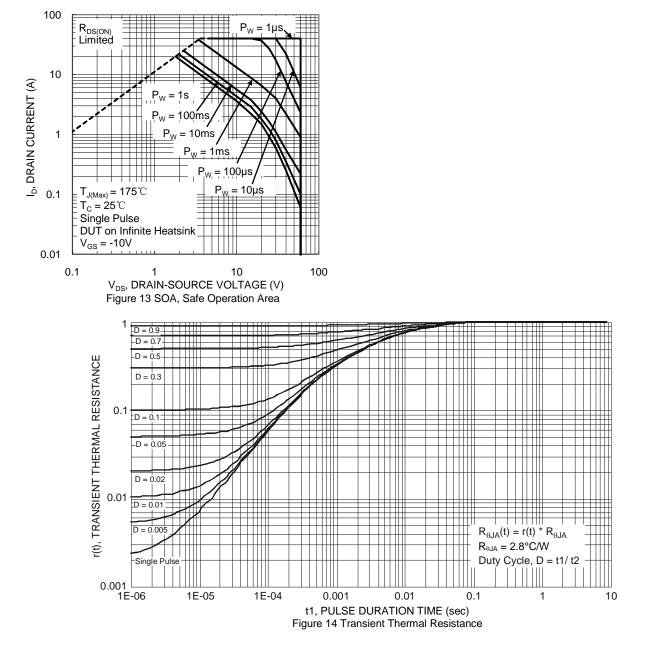








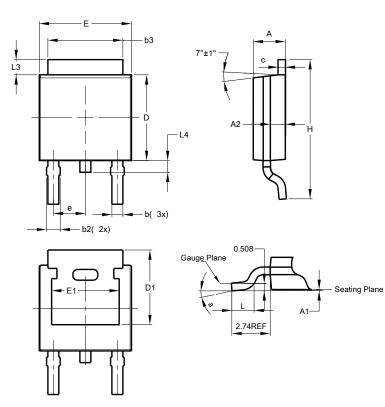






## **Package Outline Dimensions**

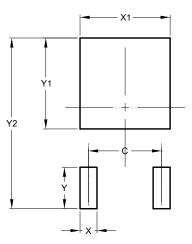
Please see http://www.diodes.com/package-outlines.html for the latest version.



TO252 (DPAK)					
Dim	Min	Max	́Тур		
Α	2.19	2.39	2.29		
A1	0.00	0.13	0.08		
A2	0.97	1.17	1.07		
b	0.64	0.88	0.783		
b2	0.76	1.14	0.95		
b3	5.21	5.46	5.33		
С	0.45	0.58	0.531		
D	6.00	6.20	6.10		
D1	5.21	-	-		
е	-	-	2.286		
Ε	6.45	6.70	6.58		
E1	4.32	-	-		
Н	9.40	10.41	9.91		
L	1.40	1.78	1.59		
L3	0.88	1.27	1.08		
L4	0.64	1.02	0.83		
а	0°	10°	-		
All	All Dimensions in mm				

## **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.



	TO252	(DPAK)
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TO252 (DPAK)

Dimensions	Value (in mm)
С	4.572
Х	1.060
X1	5.632
Y	2.600
Y1	5.700
Y2	10.700



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